



BSI Standards Publication

Field device tool (FDT) interface specification

Part 302: Communication profile integration — IEC 61784 CPF 2

National foreword

This British Standard is the UK implementation of EN IEC 62453-302:2023. It is identical to IEC 62453-302:2023. It supersedes BS EN 62453-302:2017, which is withdrawn.

The UK participation in its preparation was entrusted to Technical Committee GEL/65/3, Industrial communications: process measurement and control, including fieldbus.

A list of organizations represented on this committee can be obtained on request to its committee manager.

Contractual and legal considerations

This publication has been prepared in good faith, however no representation, warranty, assurance or undertaking (express or implied) is or will be made, and no responsibility or liability is or will be accepted by BSI in relation to the adequacy, accuracy, completeness or reasonableness of this publication. All and any such responsibility and liability is expressly disclaimed to the full extent permitted by the law.

This publication is provided as is, and is to be used at the recipient's own risk.

The recipient is advised to consider seeking professional guidance with respect to its use of this publication.

This publication is not intended to constitute a contract. Users are responsible for its correct application.

© The British Standards Institution 2024
Published by BSI Standards Limited 2024

ISBN 978 0 539 15388 0

ICS 25.040.40; 35.100.05; 35.110

Compliance with a British Standard cannot confer immunity from legal obligations.

This British Standard was published under the authority of the Standards Policy and Strategy Committee on 31 January 2024.

Amendments/corrigenda issued since publication

Date	Text affected
------	---------------

English Version

Field device tool (FDT) interface specification - Part 302:
Communication profile integration - IEC 61784 CPF 2
(IEC 62453-302:2023)

Spécification des interfaces des outils des dispositifs de terrain (FDT) - Partie 302: Intégration des profils de communication - CPF 2 de l'IEC 61784
(IEC 62453-302:2023)

Field Device Tool (FDT)-Schnittstellenspezifikation - Teil 302: Integration von Kommunikationsprofilen - Kommunikationsprofilfamilie (CPF) 2 nach IEC 61784
(IEC 62453-302:2023)

This European Standard was approved by CENELEC on 2023-12-13. CENELEC members are bound to comply with the CEN/CENELEC Internal Regulations which stipulate the conditions for giving this European Standard the status of a national standard without any alteration.

Up-to-date lists and bibliographical references concerning such national standards may be obtained on application to the CEN-CENELEC Management Centre or to any CENELEC member.

This European Standard exists in three official versions (English, French, German). A version in any other language made by translation under the responsibility of a CENELEC member into its own language and notified to the CEN-CENELEC Management Centre has the same status as the official versions.

CENELEC members are the national electrotechnical committees of Austria, Belgium, Bulgaria, Croatia, Cyprus, the Czech Republic, Denmark, Estonia, Finland, France, Germany, Greece, Hungary, Iceland, Ireland, Italy, Latvia, Lithuania, Luxembourg, Malta, the Netherlands, Norway, Poland, Portugal, Republic of North Macedonia, Romania, Serbia, Slovakia, Slovenia, Spain, Sweden, Switzerland, Türkiye and the United Kingdom.



European Committee for Electrotechnical Standardization
Comité Européen de Normalisation Electrotechnique
Europäisches Komitee für Elektrotechnische Normung

CEN-CENELEC Management Centre: Rue de la Science 23, B-1040 Brussels

European foreword

The text of document 65E/1031/FDIS, future edition 3 of IEC 62453-302, prepared by SC 65E "Devices and integration in enterprise systems" of IEC/TC 65 "Industrial-process measurement, control and automation" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 62453-302:2023.

The following dates are fixed:

- latest date by which the document has to be implemented at national level by publication of an identical national standard or by endorsement (dop) 2024-09-13
- latest date by which the national standards conflicting with the document have to be withdrawn (dow) 2026-12-13

This document supersedes EN 62453-302:2017 and all of its amendments and corrigenda (if any).

Attention is drawn to the possibility that some of the elements of this document may be the subject of patent rights. CENELEC shall not be held responsible for identifying any or all such patent rights.

Any feedback and questions on this document should be directed to the users' national committee. A complete listing of these bodies can be found on the CENELEC website.

Endorsement notice

The text of the International Standard IEC 62453-302:2023 was approved by CENELEC as a European Standard without any modification.

In the official version, for Bibliography, the following note has to be added for the standard indicated:

IEC 62453 (series) NOTE Approved as EN 62453 (series)

Annex ZA (normative)

Normative references to international publications with their corresponding European publications

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: www.cenelec.eu.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 61158-2	-	Industrial communication networks - Fieldbus specifications - Part 2: Physical layer specification and service definition	EN IEC 61158-2	-
IEC 61158-3-2	-	Industrial communication networks - Fieldbus specifications - Part 3-2: Data-link layer service definition - Type 2 elements	EN 62258-3-2	-
IEC 61158-4-2	-	Industrial communication networks - Fieldbus specifications - Part 4-2: Data-link layer protocol specification - Type 2 elements	EN IEC 61158-4-2	-
IEC 61158-5-2	2019	Industrial communication networks - Fieldbus specifications - Part 5-2: Application layer service definition - Type 2 elements	EN IEC 61158-5-2	2019
IEC 61158-6-2	2019	Industrial communication networks - Fieldbus specifications - Part 6-2: Application layer protocol specification - Type 2 elements	EN IEC 61158-6-2	2019
IEC 61784-1	-	Industrial communication networks - Profiles Part 1: Fieldbus profiles	EN IEC 61784-1	-
IEC 61784-2	-	Industrial communication networks - Profiles - Part 2: Additional fieldbus profiles for real-time networks based on ISO/IEC/IEEE 8802-3	EN IEC 61784-2	-
IEC 61784-3-2	2021	Industrial communication networks - Profiles - Part 3-2: Functional safety fieldbuses - Additional specifications for CPF 2	EN IEC 61784-3-2	2021
IEC 62026-3	-	Low-voltage switchgear and controlgear - Controller-device interfaces (CDIs) - Part 3: DeviceNet	EN 62026-3	-

EN IEC 62453-302:2023 (E)

IEC 62026-7	-	Low-voltage switchgear and controlgear - EN 62026-7 Controller-device interfaces (CDIs) - Part 7: CompoNet	-
IEC 62453-1	— ¹	Field device tool (FDT) interface specification - Part 1: Overview and guidance	EN IEC 62453-1 — ²
IEC 62453-2	2022	Field device tool (FDT) interface specification - Part 2: Concepts and detailed description	EN IEC 62453-2 2022
ISO 15745-2	2003	Industrial automation systems and integration - Open systems application integration framework - Part 2: Reference description for ISO 11898-based control systems	- -
ISO 15745-3	2003	Industrial automation systems and integration - Open systems application integration framework - Part 3: Reference description for IEC 61158 based control systems	- -

¹ Under preparation. Stage at time of publication: IEC/RPUB 62453-1:2022.

² Under preparation. Stage at time of publication: prEN IEC 62453-1:2022.

CONTENTS

FOREWORD.....	4
INTRODUCTION.....	6
1 Scope.....	7
2 Normative references	7
3 Terms, definitions, symbols, abbreviated terms and conventions	8
3.1 Terms and definitions.....	8
3.2 Symbols and abbreviated terms	8
3.3 Conventions.....	9
3.3.1 Data type names and references to data types	9
3.3.2 Vocabulary for requirements	9
4 Bus category	9
5 Access to instance and device data	11
6 Protocol specific behavior.....	11
7 Protocol specific usage of general data types	11
8 Protocol specific common data types	12
9 Network management data types	16
9.1 General.....	16
9.2 Node address	16
9.3 Scanner/master – Bus parameter set (CIP)	16
10 Communication data types.....	24
11 Channel parameter data types	27
12 Device identification	29
12.1 Device type identification data types	29
12.2 Topology scan data types	30
12.3 Scan identification data types	30
12.4 Device type identification data types	31
Annex A (informative) Implementation hints	33
A.1 Addressing in CompoNet DTMs	33
A.2 Displaying addresses of CompoNet DTMs	34
A.3 Handling of Config1 and Config2 elements in EtherNet/IP	34
Bibliography.....	35
Figure 1 – Part 302 of the IEC 62453 series	6
Figure A.1 – Examples of DTM naming for CompoNet.....	34
Table 1 – Protocol identifiers	9
Table 2 – Physical layer identifiers for DeviceNet	9
Table 3 – Physical layer identifiers for ControlNet.....	9
Table 4 – Physical layer identifiers for EtherNet/IP	10
Table 5 – Physical layer identifiers for CompoNet	10
Table 6 – Data link layer identifiers	10
Table 7 – Protocol specific usage of general data types.....	11
Table 8 – Simple protocol specific common data types	12

Table 9 – Structured protocol specific common data types	14
Table 10 – Simple fieldbus configuration data types.....	16
Table 11 – Structured fieldbus configuration data types	18
Table 12 – Simple communication data types	25
Table 13 – Structured communication data types	25
Table 14 – Simple channel parameter data types.....	27
Table 15 – Structured channel parameter data types	28
Table 16 – Identification data types with protocol specific mapping	30
Table 17 – Simple identification data types with protocol independent semantics.....	30
Table 18 – Structured identification data types with protocol independent semantics	30
Table 19 – Simple scan identification data types.....	31
Table 20 – Structured scan identification data types	31
Table 21 – Structured device type identification data types	32
Table A.1 – CompoNet relationship between Device Category, Node Address, MAC ID	33

INTERNATIONAL ELECTROTECHNICAL COMMISSION

FIELD DEVICE TOOL (FDT) INTERFACE SPECIFICATION –

**Part 302: Communication profile integration –
IEC 61784 CPF 2**

FOREWORD

- 1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as "IEC Publication(s)"). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.
- 2) The formal decisions or agreements of IEC on technical matters express, as nearly as possible, an international consensus of opinion on the relevant subjects since each technical committee has representation from all interested IEC National Committees.
- 3) IEC Publications have the form of recommendations for international use and are accepted by IEC National Committees in that sense. While all reasonable efforts are made to ensure that the technical content of IEC Publications is accurate, IEC cannot be held responsible for the way in which they are used or for any misinterpretation by any end user.
- 4) In order to promote international uniformity, IEC National Committees undertake to apply IEC Publications transparently to the maximum extent possible in their national and regional publications. Any divergence between any IEC Publication and the corresponding national or regional publication shall be clearly indicated in the latter.
- 5) IEC itself does not provide any attestation of conformity. Independent certification bodies provide conformity assessment services and, in some areas, access to IEC marks of conformity. IEC is not responsible for any services carried out by independent certification bodies.
- 6) All users should ensure that they have the latest edition of this publication.
- 7) No liability shall attach to IEC or its directors, employees, servants or agents including individual experts and members of its technical committees and IEC National Committees for any personal injury, property damage or other damage of any nature whatsoever, whether direct or indirect, or for costs (including legal fees) and expenses arising out of the publication, use of, or reliance upon, this IEC Publication or any other IEC Publications.
- 8) Attention is drawn to the Normative references cited in this publication. Use of the referenced publications is indispensable for the correct application of this publication.
- 9) Attention is drawn to the possibility that some of the elements of this IEC Publication may be the subject of patent rights. IEC shall not be held responsible for identifying any or all such patent rights.

IEC 62453-302 has been prepared by subcommittee 65E: Devices and integration in enterprise systems, of IEC technical committee 65: Industrial-process measurement, control and automation. It is an International Standard.

This third edition cancels and replaces the second edition published in 2016. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) improved support for Ethernet IP (see 9.3, Clause 10, and 12.4).

Each part of the IEC 62453-3xy series is intended to be read in conjunction with IEC 62453-2.

The text of this International Standard is based on the following documents:

Draft	Report on voting
65E/1031/FDIS	65E/1032/RVD

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at www.iec.ch/members_experts/refdocs. The main document types developed by IEC are described in greater detail at www.iec.ch/standardsdev/publications.

A list of all parts of the IEC 62453 series, under the general title *Field Device Tool (FDT) interface specification*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under webstore.iec.ch in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

IMPORTANT – The "colour inside" logo on the cover page of this document indicates that it contains colours which are considered to be useful for the correct understanding of its contents. Users should therefore print this document using a colour printer.

INTRODUCTION

This part of IEC 62453 is an interface specification for developers of FDT (Field Device Tool) components for function control and data access within a client/server architecture. The specification is a result of an analysis and design process to develop standard interfaces to facilitate the development of servers and clients by multiple vendors that need to interoperate seamlessly.

With the integration of fieldbusses into control systems, there are a few other tasks which need to be performed. In addition to fieldbus- and device-specific tools, there is a need to integrate these tools into higher-level system-wide planning or engineering tools. In particular, for use in extensive and heterogeneous control systems, typically in the area of the process industry, the unambiguous definition of engineering interfaces that are easy to use for all those involved is of great importance.

A device-specific software component, called DTM (Device Type Manager), is supplied by the field device manufacturer with its device. The DTM is integrated into engineering tools via the FDT interfaces defined in this specification. The approach to integration is in general open for all kinds of fieldbusses and thus meets the requirements for integrating different kinds of devices into heterogeneous control systems.

Figure 1 shows how IEC 62453-302 is aligned in the structure of the IEC 62453 series [1].

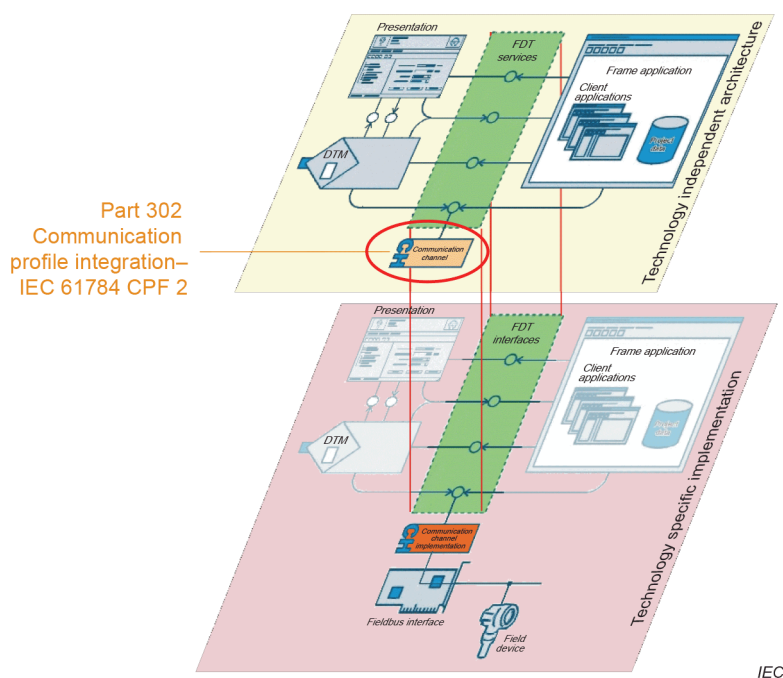


Figure 1 – Part 302 of the IEC 62453 series

NOTE For an example for the technology specific implementation of this document, see [2].

FIELD DEVICE TOOL (FDT) INTERFACE SPECIFICATION –

Part 302: Communication profile integration – IEC 61784 CPF 2

1 Scope

This part of IEC 62453 provides information for integrating the CIP™ technology into the FDT interface specification (IEC 62453-2). Communication Profile Family 2 (commonly known as CIP™¹) defines communication profiles based on IEC 61158-2 Type 2, IEC 61158-3-2, IEC 61158-4-2, IEC 61158-5-2, IEC 61158-6-2, and IEC 62026-3. The basic profiles CP 2/1 (ControlNet™²), CP 2/2 (EtherNet/IP™³), and CP 2/3 (DeviceNet™¹) are defined in IEC 61784-1 and IEC 61784-2. An additional communication profile (CompoNet™¹), also based on CIP™, is defined in IEC 62026-7.

This part of IEC 62453 specifies communication and other services.

This specification neither contains the FDT specification nor modifies it.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 61158-2, *Industrial communication networks – Fieldbus specifications – Part 2: Physical layer specification and service definition*

IEC 61158-3-2⁴, *Industrial communication networks – Fieldbus specifications – Part 3-2: Data-link layer service definition – Type 2 elements*

IEC 61158-4-2, *Industrial communication networks – Fieldbus specifications – Part 4-2: Data-link layer protocol specification – Type 2 elements*

¹ CIP™ (Common Industrial Protocol), DeviceNet™ and CompoNet™ are trade names of Open DeviceNet Vendor Association, Inc (ODVA). This information is given for the convenience of users of this document and does not constitute an endorsement by IEC of the trade name holder or any of its products. Compliance to this standard does not require use of the trade names CIP™, DeviceNet™ or CompoNet™. Use of the trade names CIP™, DeviceNet™ or CompoNet™ requires permission of Open DeviceNet Vendor Association, Inc.

² ControlNet™ is a trade name of ControlNet International, Ltd. This information is given for the convenience of users of this document and does not constitute an endorsement by IEC of the trademark holder or any of its products. Compliance to this profile does not require use of the trade name ControlNet™. Use of the trade name ControlNet™ requires permission of ControlNet International, Ltd.

³ EtherNet/IP™ is a trade name of ControlNet International, Ltd. and Open DeviceNet Vendor Association, Inc. This information is given for the convenience of users of this document and does not constitute an endorsement by IEC of the trademark holder or any of its products. Compliance to this profile does not require use of the trade name EtherNet/IP™. Use of the trade name EtherNet/IP™ requires permission of either ControlNet International, Ltd. or Open DeviceNet Vendor Association, Inc.

⁴ A consolidated version of this document exists, comprising the second edition (2014-08) [documents 65C/759/FDIS and 65C/769/RVD] and its amendment 1 (2019-04) [documents 65C/945/FDIS and 65C/954/RVD].

IEC 61158-5-2:2019, *Industrial communication networks – Fieldbus specifications – Part 5-2: Application layer service definition – Type 2 elements*

IEC 61158-6-2:2019, *Industrial communication networks – Fieldbus specifications – Part 6-2: Application layer protocol specification – Type 2 elements*

IEC 61784-1, *Industrial communication networks – Profiles – Part 1: Fieldbus profiles*

IEC 61784-2, *Industrial communication networks – Profiles – Part 2: Additional fieldbus profiles for real-time networks based on ISO/IEC/IEEE 8802-3*

IEC 61784-3-2:2021, *Industrial communication networks – Profiles – Part 3-2: Functional safety fieldbuses – Additional specifications for CPF 2*

IEC 62026-3, *Low-voltage switchgear and controlgear – Controller-device interfaces (CDIs) – Part 3: DeviceNet*

IEC 62026-7, *Low-voltage switchgear and controlgear – Controller-device interfaces (CDIs) – Part 7: CompoNet*

IEC 62453-1:–⁵, *Field device tool (FDT) interface specification – Part 1: Overview and guidance*

IEC 62453-2:2022, *Field device tool (FDT) interface specification – Part 2: Concepts and detailed description*

ISO 15745-2:2003, *Industrial automation systems and integration – Open systems application integration framework – Part 2: Reference description for ISO 11898-based control systems*

ISO 15745-3:2003, *Industrial automation systems and integration – Open systems application integration framework – Part 3: Reference description for IEC 61158-based control systems*

3 Terms, definitions, symbols, abbreviated terms and conventions

3.1 Terms and definitions

For the purposes of this document, the terms and definitions given in IEC 62453-1 and IEC 62453-2 apply.

ISO and IEC maintain terminological databases for use in standardization at the following addresses:

- IEC Electropedia: available at <http://www.electropedia.org/>
- ISO Online browsing platform: available at <http://www.iso.org/obp>

3.2 Symbols and abbreviated terms

For the purposes of this document, the symbols and abbreviations given in IEC 62453-1, IEC 62453-2, as well as the following apply.

CIP™	Common Industrial Protocol
EDS	Electronic Data Sheet

⁵ Under preparation. Stage at the time of publication: IEC/RPUB 62453-1:2022.
To be published concurrently with this document.